

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







DUAL 30V N-CHANNEL ENHANCEMENT MODE MOSFET

SUMMARY

 $V_{(BR)DSS}$ = 30V; $R_{DS(ON)}$ = 0.035 Ω ; I_D = 6.2A

DESCRIPTION

This new generation of TRENCH MOSFETs from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.



S08

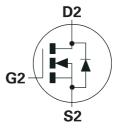
FEATURES

- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- Low profile SOIC package

APPLICATIONS

- DC DC Converters
- Power Management Functions
- Disconnect switches
- Motor control

G1 S1



ORDERING INFORMATION

DEVICE	REEL	TAPE WIDTH	QUANTITY PER REEL
ZXMN3A06DN8TA	7''	12mm	500 units
ZXMN3A06DN8TC	13''	12mm	2500 units

DEVICE MARKING

ZXMN 3A06D

PINOUT



Top view



ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DSS}	30	V
Gate Source Voltage	V _{GS}	±20	V
$ \begin{array}{c} \text{Continuous Drain Current } (V_{GS} = 10V; T_A = 25^{\circ}\text{C})(b)(d) \\ (V_{GS} = 10V; T_A = 70^{\circ}\text{C})(b)(d) \\ (V_{GS} = 10V; T_A = 25^{\circ}\text{C})(a)(d) \end{array} $	I _D	6.2 5.0 4.9	А
Pulsed Drain Current (c)	I _{DM}	30	А
Continuous Source Current (Body Diode) (b)	I _S	3.7	А
Pulsed Source Current (Body Diode)(c)	I _{SM}	30	А
Power Dissipation at T _A =25°C (a)(d) Linear Derating Factor	P _D	1.25 10	W mW/°C
Power Dissipation at T _A =25°C (a)(e) Linear Derating Factor	P _D	1.80 14.5	W mW/°C
Power Dissipation at T _A =25°C (b)(d) Linear Derating Factor	P _D	2.1 17.3	W mW/°C
Operating and Storage Temperature Range	T _j :T _{stg}	-55 to +150	°C

THERMAL RESISTANCE

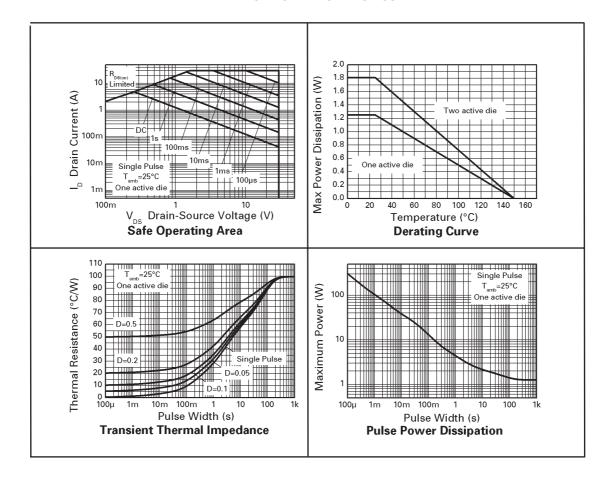
PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient (a)(d)	$R_{\theta JA}$	100	°C/W
Junction to Ambient (a)(e)	$R_{\theta JA}$	69	°C/W
Junction to Ambient (b)(d)	$R_{\theta JA}$	58	°C/W

NOTES

- $(a) For a device surface mounted on 25 mm\ x\ 25 mm\ FR4\ PCB\ with\ high\ coverage\ of\ single\ sided\ 1oz\ copper,\ in\ still\ air\ conditions$
- (b) For a device surface mounted on FR4 PCB measured at t≤10 secs.
- (c) Repetitive rating 25mm x 25mm FR4 PCB, D=0.02 pulse width= $300\mu s$ pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.
- (d) For device with one active die
- (e) For device with two active die running at equal power.



TYPICAL CHARACTERISTICS





ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^{\circ}C$ unless otherwise stated).

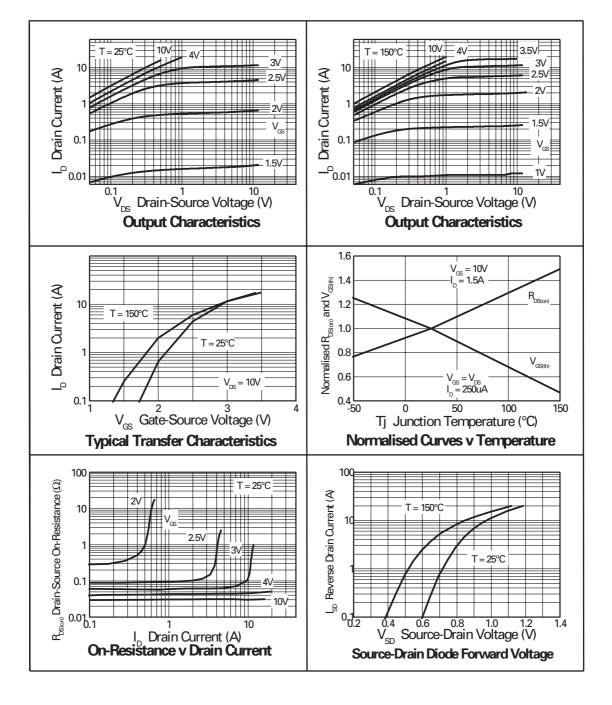
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.	
STATIC							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	30			V	I _D =250μA, V _{GS} =0V	
Zero Gate Voltage Drain Current	I _{DSS}			0.5	μΑ	V _{DS} =30V, V _{GS} =0V	
Gate-Body Leakage	I _{GSS}			100	nA	V _{GS} =±20V, V _{DS} =0V	
Gate-Source Threshold Voltage	V _{GS(th)}	1			V	I _D =250μA, V _{DS} = V _{GS}	
Static Drain-Source On-State Resistance (1)	R _{DS(on)}			0.035 0.050	Ω	V _{GS} =10V, I _D =9A V _{GS} =4.5V, I _D =7.4A	
Forward Transconductance (1)(3)	9fs		13.5		S	V _{DS} =15V,I _D =9A	
DYNAMIC (3)		•			•		
Input Capacitance	C _{iss}		796		pF		
Output Capacitance	Coss		137		pF	V _{DS} =25 V, V _{GS} =0V, I _{f=1MHz}	
Reverse Transfer Capacitance	C _{rss}		83.5		pF	1-111112	
SWITCHING(2) (3)				•	•		
Turn-On Delay Time	t _{d(on)}		3.0		ns		
Rise Time	t _r		6.4		ns	V _{DD} =15V, I _D =3.5A	
Turn-Off Delay Time	t _{d(off)}		21.6		ns	$R_{G}=6.0\Omega$, $V_{GS}=10V$	
Fall Time	t _f		9.4		ns		
Gate Charge	Q_g		9.2		nC	V _{DS} =15V,V _{GS} =5V, I _D =3.5A	
Total Gate Charge	Qg		17.5		nC	V _{DS} =15V,V _{GS} =10V, I _D =3.5A	
Gate-Source Charge	Q _{gs}		2.3		nC		
Gate-Drain Charge	Q _{gd}		3.1		nC		
SOURCE-DRAIN DIODE							
Diode Forward Voltage (1)	V _{SD}		0.85	0.95	V	T _J =25°C, I _S =5.1A, V _{GS} =0V	
Reverse Recovery Time (3)	t _{rr}		17.8		ns	T _J =25°C, I _F =3.5A, di/dt= 100A/μs	
Reverse Recovery Charge (3)	O _{rr}		11.6		nC		

NOTES

- (1) Measured under pulsed conditions. Width ${\leq}300\mu s.$ Duty cycle ${\leq}~2\%$.
- (2) Switching characteristics are independent of operating junction temperature.
- (3) For design aid only, not subject to production testing.



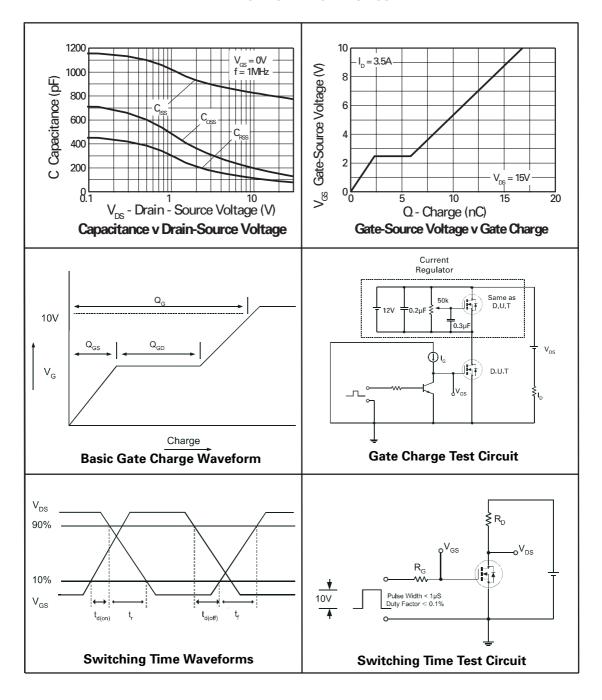
TYPICAL CHARACTERISTICS





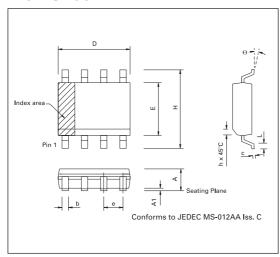


TYPICAL CHARACTERISTICS





PACKAGE OUTLINE



CONTROLLING DIMENSIONS ARE IN INCHES APPROX IN MILLIMETRES

PACKAGE DIMENSIONS

DINA	INCI	HES	MILLIMETRES				
DIM	MIN	MAX	MIN	MAX			
А	0.053	0.069	1.35	1.75			
A1	0.004	0.010	0.10	0.25			
D	0.189	0.197	4.80	5.00			
Н	0.228	0.244	5.80	6.20			
Е	0.150	0.157	3.80	4.00			
L	0.016	0.050	0.40	1.27			
е	0.050	0.050 BSC		BSC			
b	0.013	0.020	0.33	0.51			
С	0.008	0.010	0.19	0.25			
θ	0°	8°	0°	8°			
h	0.010	0.020	0.25	0.50			

© Zetex plc 2002

Zetex plc Fields New Road Chadderton Oldham, OL9 8NP United Kingdom Telephone (44) 161 622 4422 Fax: (44) 161 622 4420

Zetex GmbH Streitfeldstraße 19 D-81673 München

Germany Telefon: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 Zetex Inc 700 Veterans Memorial Hwy Hauppauge, NY11788

USA

Telephone: (631) 360 2222 Fax: (631) 360 8222 Zetex (Asia) Ltd 3701-04 Metroplaza, Tower 1 Hing Fong Road Kwai Fong Hong Kong

Hong Kong Telephone: (852) 26100 611 Fax: (852) 24250 494

These offices are supported by agents and distributors in major countries world-wide.

This publication is issued to provide outline information only which (unless agreed by the Company in writing) may not be used, applied or reproduced for any purpose or form part of any order or contract or be regarded as a representation relating to the products or services concerned. The Company reserves the right to alter without notice the specification, design, price or conditions of supply of any product or service.

For the latest product information, log on to $\boldsymbol{www.zetex.com}$

